

DESCRIPTION

The MP6529 is a gate driver IC designed for three-phase, brushless DC motor driver applications; it is capable of driving three halfbridges consisting of six N-channel power MOSFETs up to 35V.

The MP6529 uses a bootstrap capacitor to generate a supply voltage for the high-side MOSFET driver. An internal trickle-charge circuit maintains a sufficient gate driver voltage at 100% duty cycle.

Full protection features include programmable over-current protection (OCP), adjustable deadtime control, under-voltage lockout (UVLO), and thermal shutdown.

The MP6529 is available in a 28-pin TSSOP (9.7mmx6.4mm) package with an exposed thermal pad and a 28-contact QFN (4mmx4mm) package with an exposed thermal pad.

FEATURES

- Wide 5V to 35V Input Voltage Range
- Bootstrap Gate Driver with Trickle-Charge Circuit Supports 100% Duty Cycle Operation
- Low-Power Sleep Mode for Battery-Powered Applications
- Programmable Over-Current Protection of External MOSFETs
- Adjustable Dead-Time Control to Prevent Shoot-Through
- Thermal Shutdown and UVLO Protection
- Fault Indication Output
- Thermally Enhanced Surface-Mount Package

APPLICATIONS

- Three-Phase, Brushless DC Motors and Permanent Magnet Synchronous Motors
- Power Drills
- Impact Drivers
- E-Cigar
- E-Bike

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TYPICAL APPLICATION





ORDERING INFORMATION

Part Number	Package	Top Marking
MP6529GR*	QFN-28 (4mmx4mm)	See Below
MP6529GF**	TSSOP-28 EP (9.7mmx6.4mm)	See Below

* For Tape & Reel, add suffix –Z (e.g. MP6529GR–Z) ** For Tape & Reel, add suffix –Z (e.g. MP6529GF–Z)

TOP MARKING (MP6529GR)

<u>MPSYWW</u>

MP6529

LLLLLL

MPS: MPS prefix Y: Year code WW: Week code MP6529: Part number LLLLLL: Lot number

TOP MARKING (MP6529GF)

M<u>PSYYWW</u>

MP6529

LLLLLLLL

MPS: MPS prefix YY: Year code WW: Week code MP6529: Part number LLLLLLLL: Lot number





PACKAGE REFERENCE

ABSOLUTE MAXIMUM RATINGS (1)

Input voltage (V _{IN})	0.3V to 40V
CPA	0.3V to 40V
СРВ	0.3V to 12.5V
VREG	0.3V to 13V
BSTA/B/C	0.3V to 55V
GHA/B/C	0.3V to 55V
SHA/B/C	0.3V to 40V
GLA/B/C	0.3V to 13V
All other pins to AGND	0.3V to 6.5V
Continuous power dissipation (7	Γ _A = +25°C) ⁽²⁾
QFN-28 (4mmx4mm)	2.9W
TSSOP-28 EP (9.7mmx6.4mn	n)3.9W
Storage temperature	-55°C to +150°C
Junction temperature	+150°C
Lead temperature (solder)	

Recommended Operating Conditions ⁽³⁾

Input voltage (V _{IN})	5V to 35V
OC_REF voltage (Voc)	0.125V to 2.4V
Operating junct. temp (T _J)	40°C to +125°C

Thermal Resistance ⁽⁴⁾ $\theta_{JA} = \theta_{JC}$

QFN-28 (4mmx4mm)......429...°C/W TSSOP-28 EP (9.7mmx6.4mm)..326....°C/W

NOTES:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature T_J (MAX), the junction-toambient thermal resistance θ_{JA} , and the ambient temperature T_A. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D (MAX) = (T_J (MAX)-T_A)/ θ_{JA} . Exceeding the maximum allowable power dissipation produces an excessive die temperature, causing the regulator to go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.



MP6529 - 5V TO 35V, THREE-PHASE BLDC MOTOR PRE-DRIVER

ELECTRICAL CHARACTERISTICS

 V_{IN} = 24V, T_A = 25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Power Supply						
Input supply voltage	Vin		5		35	V
Quiescent current	ا _م	nSLEEP = 1, gate not switching		0.95	2	mA
	I _{SLEEP}	nSLEEP = 0			1	μA
Control Logic						
Input logic low threshold	VIL				0.8	V
Input logic high threshold	VIH		2			V
Logic input current	I _{IN(H)}	V _{IH} = 5V	-20		20	μA
<u> </u>	I _{IN(L)}	V _{IL} = 0.8V	-20		20	μA
nSLEEP pull-down current	ISLEEP-PD			1		μA
Internal pull-down resistance	R _{PD}			880		kΩ
Fault Outputs (Open-Drain Ou	utputs)			-	_	
Output low voltage	Vol	Io = 5mA			0.5	V
Output high leakage current	Іон	Vo = 3.3V			1	μA
Protection Circuit		-		-	_	
UVLO rising threshold	V_{IN_RISE}		3.3	3.9	4.5	V
UVLO hysteresis	V _{IN_HYS}			200		mV
VREG rising threshold	V _{REG_RISE}		6.8	7.6	8.4	V
VREG hysteresis	V _{REG_HYS}			0.54	1	V
VREG start-up delay	t _{REG}			700		μs
OC_REF threshold	Voc	V _{oc} = 1V V _{oc} = 2.4V	0.8	1 2.4	1.2 2.62	V
OCP deglitch time	toc	V0C - 2.4V	2.10	3	2.02	μs
SLEEP wake-up time	tSLEEP			1		ms
LSS OCP threshold	VLSS-OCP		0.4	0.5	0.6	V
Thermal shutdown	T _{TSD}			150		°C



MP6529 - 5V TO 35V, THREE-PHASE BLDC MOTOR PRE-DRIVER

ELECTRICAL CHARACTERISTICS (continued)

 V_{IN} = 24V, T_A = 25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Gate Drive						
Bootstrap diode forward voltage	Vfboot	I _D = 10mA			0.9	V
Bootstrap diode forward voltage		I _D = 100mA			1.3	V
VREG output voltage	V _{REG}	V _{IN} = 5.5V-35V	10	11.5	12.8	
VREG output voltage		$V_{IN} = 5V$	2xV _{IN} -1			V
Maximum source current	I _{OSO} ⁽⁵⁾			0.8		А
Maximum sink current	losi ⁽⁵⁾			1		А
Gate drive pull-up resistance	Rup	V _{DS} = 1V		8		Ω
HS gate drive pull-down resistance	R _{HS-DN}	V _{DS} = 1V	1.2		4.7	Ω
LS gate drive pull-down resistance	RLS-DN	V _{DS} = 1V	1		5.5	Ω
LS passive pull-down resistance	RLS-PDN			590		kΩ
LS automatic turn-on time	t∟s			1.8		μs
Charge pump frequency	fсР			110		kHz
	tdead	Leave DT open		6		μs
Dead time		R _{DT} = 200kΩ		0.74		μs
		DT tied to GND		30		ns

NOTE:

5) Guaranteed by design.



TYPICAL CHARACTERISTICS

 V_{IN} = 24V, OC_REF = 0.5V, R_{DT} = 200k, ENA = ENC = H, F_{PWMA} = 20kHz, T_A = 25°C, resistor + inductor load: 5 Ω + 1mH/phase with star connection, unless otherwise noted.





TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 V_{IN} = 24V, OC_REF = 0.5V, R_{DT} = 200k, ENA = ENC = H, F_{PWMA} = 20kHz, T_A = 25°C, resistor + inductor load: 5 Ω + 1mH/phase with star connection, unless otherwise noted.





MP6529 Rev. 1.01 5/28/2019 www.MonolithicPower.com Patent Protected. Unauthorized Photoco

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TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 V_{IN} = 24V, OC_REF = 0.5V, R_{DT} = 200k, ENA = ENC = H, F_{PWMA} = 20kHz, T_A = 25°C, resistor + inductor load: 5 Ω + 1mH/phase with star connection, unless otherwise noted.





PIN FUNCTIONS

QFN-28 Pin #	TSSOP-28	Name	Name Description		
1 Pin #	Pin # 26	VIN	Input supply voltage.		
2	20	CPA	Charge pump capacitor connect terminal.		
-					
3	28	CPB	Charge pump capacitor connect terminal.		
4	1	VREG	Gate driver supply output.		
5	2	BSTA	Bootstrap output phase A.		
6	3	SHA	High-side source connection phase A.		
7	4	GHA	High-side gate drive phase A.		
8	5	GLA	Low-side gate drive phase A.		
9	6	BSTB	Bootstrap output phase B.		
10	7	SHB	High-side source connection phase B.		
11	8	GHB	High-side gate drive phase B.		
12	9	GLB	Low-side gate drive phase B.		
13	10	BSTC	Bootstrap output phase C.		
14	11	SHC	High-side source connection phase C.		
15	12	GHC	High-side gate drive phase C.		
16	13	GLC	Low-side gate drive phase C.		
17	14	LSS	Low-side source connection.		
18	15	PWMC	PWM input for phase C.		
19	16	PWMB	PWM input for phase B.		
20	17	PWMA	PWM input for phase A.		
01	40		Enable for phase C. Pull ENC below the specified threshold to disable		
21	18	ENC	the gate driver output for phase C.		
22	19	ENB	Enable for phase B. Pull ENB below the specified threshold to disable		
22	19	EIND	the gate driver output for phase B.		
23	20	ENA	Enable for phase A. Pull ENA below the specified threshold to disable		
23	20	ENA	the gate driver output for phase A.		
24	21	nFAULT	Fault indication. Open-drain output. nFAULT is in a fault condition at		
24	21	IFAULT	logic low.		
25	25 22 nSLE		E 00 -0	22 nSLEEP	Sleep mode input. Logic low to enter low-power sleep mode; high to
			enable. Internal pulldown.		
26	23	OC_REF	Over-current protection reference input.		
27	24	DT	Dead time setting.		
28	25	GND	Ground.		



BLOCK DIAGRAM



Figure 1: Functional Block Diagram



OPERATION

The MP6529 is a three-phase, BLDC motor predriver that can drive three half-bridges with a 0.8A source and a 1A sink current capability over a wide input voltage range of 5V to 35V. It is designed for use in battery-powered equipment. The MP6529 features a low-power sleep mode, which disables the device and draws a very low supply current.

The MP6529 provides several flexible functions, such as adjustable dead-time control and overcurrent protection (OCP), which allow the device to cover a wide range of application fields.

Input Logic

Driving nSLEEP low will put the device into a low-power sleep state. In this state, all the internal circuits are disabled, and all inputs are ignored. nSLEEP has an interval pulldown, so it must be driven high for the device to operate. When exiting sleep mode, a brief time period of approximately 1ms must pass before issuing a PWM command. This time period allows the internal circuitry to stabilize.

ENx controls the gate driver outputs of this phase. When ENx is low, the gate driver outputs are disabled, and the PWM inputs are ignored. When ENx is high, the gate driver outputs are enabled, and the PWM inputs are recognized. Refer to Table 1 below for the logic truth table.

 Table 1: Input Logic Truth Table

ENx	PWMx	SHx
Н	Н	VIN
Н	L	GND
L	х	High impendence

nFAULT

nFAULT reports to the system when a fault condition is detected, such as OCP and OTP. nFAULT can be an open-drain output, and is driven low once a fault condition occurs. If the fault condition is released, nFAULT is pulled high by an external pull-up resistor.

Over-Current Protection (OCP)

The MP6529 implements VDS sensing circuitry to protect the power stage from damage caused by high currents. Based on the R_{DS-ON} of the power MOSFETs and the maximum allowed I_{DS} , a voltage threshold can be calculated, which

triggers the over-current protection (OCP) feature when exceeded.

This voltage threshold level is programmable through the OC_REF terminal by applying an external reference voltage with a DAC. Also, OCP occurs if the LSS voltage exceeds 0.5V. Once an OCP event is detected, the MP6529 will enter a latched fault state and disable all functions. The MP6529 will stay latched off until it is reset by nSLEEP or UVLO.

OCP Deglitch Time

Usually, a current spike occurs during the switching transition due to either the body diode's reverse-recovery current or the distributed inductance or capacitance. This current spike requires filtering to prevent it from erroneously triggering OCP and shutting down the external MOSFET. An internal fixed deglitch time (t_{OC}) (which is also the minimum on time for the MOSFET) blanks the output of the VDS monitor when the outputs are switched.

Dead-Time Adjustment

To prevent a shoot-through at any phase of the bridge, it is necessary to have a dead time (t_{DEAD}) between a high- or low-side turn-off and the next complementary turn-on event. The dead time for all three phases is set by a single dead-time resistor (R_{DT}) between DT and ground and is calculated with Equation (1):

$$t_{\text{DEAD}}(nS) = 3.7^* R(k\Omega)$$
(1)

If DT is tied to GND directly, an internal minimum dead time of 30ns is applied. Leaving DT open generates a 6µs dead time.

Input UVLO Protection

If at any time the voltage on VIN falls below the under-voltage lockout threshold voltage, all circuitry in the device is disabled, and the internal logic resets. Operation resumes when VIN rises above the UVLO threshold.

Thermal Shutdown

If the die temperature exceeds its safe limits, the MP6529 enters a latched fault-state similar to an OCP event, and nFAULT is driven low. Only a reset by nSLEEP or UVLO unlatches the device from an OTP fault lockout.



PACKAGE INFORMATION







TOP VIEW

BOTTOM VIEW



SIDE VIEW





DETAIL A



RECOMMENDED LAND PATTERN

NOTE:

 ALL DIMENSIONS ARE IN MILLIMETERS.
 EXPOSED PADDLE SIZE DOES NOT INCLUDE MOLD FLASH.
 LEAD COPLANARITY SHALL BE 0.10 MILLIMETERS MAX.
 DRAWING CONFORMS TO JEDEC MO-220.
 DRAWING IS NOT TO SCALE.



PACKAGE INFORMATION



6) DRAWING IS NOT TO SCALE.

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